



**THE DATASHEET OF
BZV85-C4V7,133**



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BZV85 series

Voltage regulator diodes

Rev. 03 — 10 November 2009

Product data sheet

1. Product profile

1.1 General description

Medium-power voltage regulator diodes in small hermetically sealed leaded SOD66 (DO-41) glass packages.

The diodes are available in the normalized E24 approximately $\pm 5\%$ tolerance range. The series consists of 33 types with nominal working voltages from 3.6 V to 75 V.

1.2 Features

- Total power dissipation: max. 1.3 W
- Working voltage range: nominal 3.3 V to 75 V (E24 range)
- Small hermetically sealed glass package
- Tolerance series: approximately $\pm 5\%$
- Non-repetitive peak reverse power dissipation: max. 60 W

1.3 Applications

- Stabilization purposes

1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|---|---|-----|-----|-----|------|
| V_F | forward voltage | $I_F = 50\text{ mA}$ | - | - | 1 | V |
| P_{tot} | total power dissipation | $T_{\text{amb}} = 25\text{ }^\circ\text{C};$ lead length 10 mm | [1] | - | 1 | W |
| | | | [2] | - | 1.3 | W |
| P_{ZSM} | non-repetitive peak reverse power dissipation | square wave; $t_p = 100\text{ }\mu\text{s}$ | [3] | - | 60 | W |

[1] Device mounted on a Printed-Circuit Board (PCB) with 1 cm² copper area per lead.

[2] If the leads are kept at $T_{\text{tp}} = 55\text{ }^\circ\text{C}$ at 4 mm from body.

[3] $T_j = 25\text{ }^\circ\text{C}$ prior to surge

2. Pinning information

Table 2. Pinning

| Pin | Description | Simplified outline | Graphic symbol |
|-----|-------------|--|--|
| 1 | cathode | [1] |  006aaa152 |
| 2 | anode |  | |

[1] The marking band indicates the cathode.

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-----------------|---------|--|---------|
| | Name | Description | Version |
| BZV85 series[1] | - | hermetically sealed glass package; axial leaded; 2 leads | SOD66 |

[1] The series consists of 33 types with nominal working voltages from 3.3 V to 75 V.

4. Marking

Table 4. Marking codes

| Type number | Marking code |
|--------------|------------------------------|
| BZV85 series | The diodes are type branded. |

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---|--|-------|--------------------------------|------------------|
| I_F | forward current | | - | 500 | mA |
| I_{ZSM} | non-repetitive peak reverse current | square wave; $t_p = 100 \mu\text{s}$ | [1] - | see Table 8 | |
| | | half sine wave; $t_p = 10 \text{ ms}$ | [1] - | see Table 8 | |
| P_{tot} | total power dissipation | $T_{amb} = 25 \text{ }^\circ\text{C}$; lead length 10 mm | [2] - | 1 | W |
| | | | [3] - | 1.3 | W |
| P_{ZSM} | non-repetitive peak reverse power dissipation | square wave; $t_p = 100 \mu\text{s}$ | [1] - | 60 | W |
| T_j | junction temperature | | - | 200 | $^\circ\text{C}$ |
| T_{stg} | storage temperature | | -65 | +200 | $^\circ\text{C}$ |

[1] $T_j = 25 \text{ }^\circ\text{C}$ prior to surge

[2] Device mounted on a PCB with 1 cm² copper area per lead.

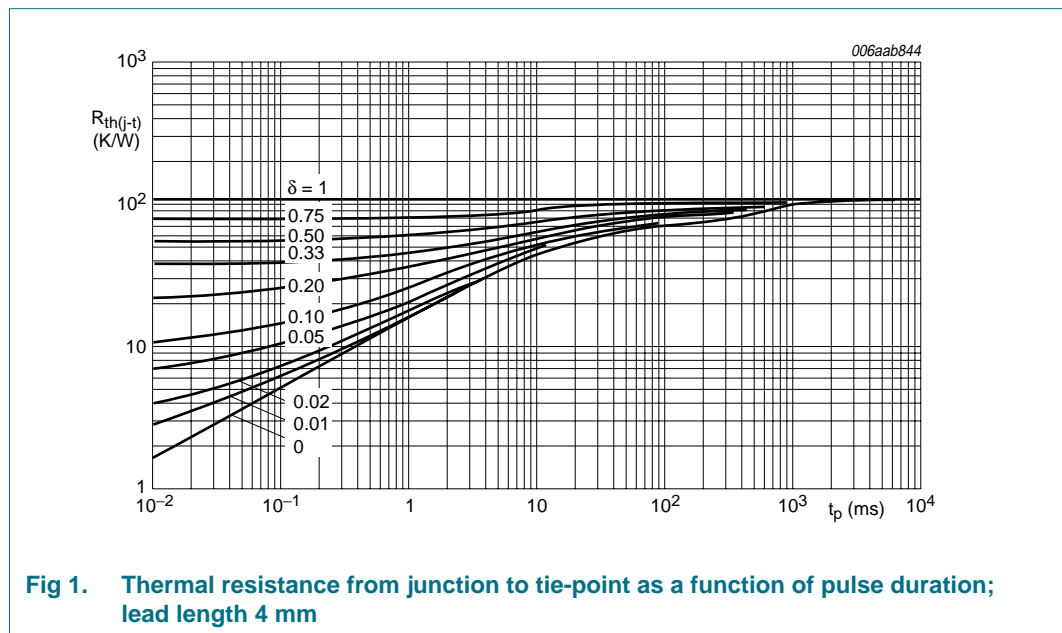
[3] If the leads are kept at $T_{ip} = 55 \text{ }^\circ\text{C}$ at 4 mm from body.

6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|---|---------------------------------------|-----|-----|-----|------|
| $R_{th(j-t)}$ | thermal resistance from junction to tie-point | lead length 4 mm | - | - | 110 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | lead length 10 mm [1] | - | - | 175 | K/W |

[1] Device mounted on a PCB with 1 cm² copper area per lead.



7. Characteristics

Table 7. Characteristics

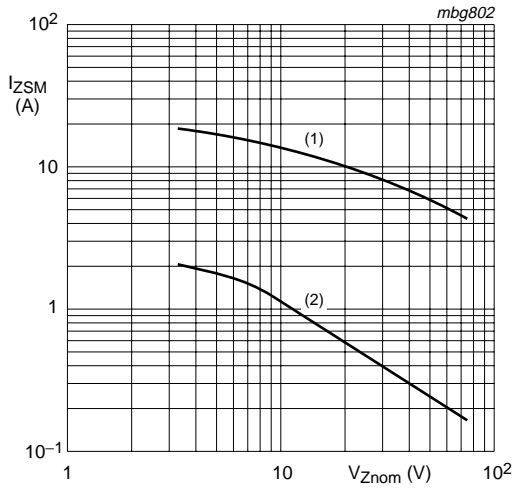
$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-----------------|----------------------|-----|-----|-----|------|
| V_F | forward voltage | $I_F = 50\text{ mA}$ | - | - | 1 | V |

Table 8. Characteristics per type

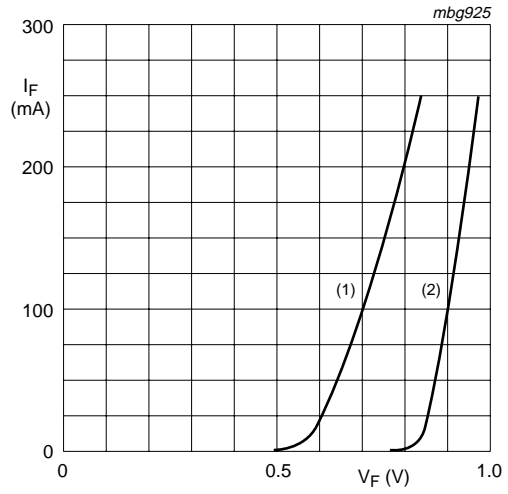
$T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified.

| BZV85-Cxxx | Working voltage V_Z (V) at I_{test} | | Differential resistance r_{dif} (Ω) at I_{test} | Temperature coefficient S_Z (mV/K) at I_{test} | | Test current I_{test} (mA) | Diode capacitance C_d (pF) at $f = 1\text{ MHz}$; $V_R = 0\text{ V}$ | Reverse current I_R (μA) | | Non-repetitive peak reverse current I_{ZSM} at $t_p = 100\ \mu\text{s}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | |
|------------|---|------|--|--|------|---------------------------------|--|--|------|---|-----------|
| | | | | Min | Max | | | Max | Max | Max | V_R (V) |
| | Min | Max | Max | Min | Max | | Max | Max | Max | V_R (V) | Max (A) |
| 3V6 | 3.4 | 3.8 | 15 | -3.5 | -1.0 | 60 | 450 | 50 | 1.0 | 8.0 | 2000 |
| 3V9 | 3.7 | 4.1 | 15 | -3.5 | -1.0 | 60 | 450 | 10 | 1.0 | 8.0 | 1950 |
| 4V3 | 4.0 | 4.6 | 13 | -2.7 | 0 | 50 | 450 | 5 | 1.0 | 8.0 | 1850 |
| 4V7 | 4.4 | 5.0 | 13 | -2.0 | 0.7 | 45 | 300 | 3 | 1.0 | 8.0 | 1800 |
| 5V1 | 4.8 | 5.4 | 10 | -0.5 | 2.2 | 45 | 300 | 3 | 2.0 | 8.0 | 1750 |
| 5V6 | 5.2 | 6.0 | 7 | 0 | 2.7 | 45 | 300 | 2 | 2.0 | 8.0 | 1700 |
| 6V2 | 5.8 | 6.6 | 4 | 0.6 | 3.6 | 35 | 200 | 2 | 3.0 | 7.0 | 1620 |
| 6V8 | 6.4 | 7.2 | 3.5 | 1.3 | 4.3 | 35 | 200 | 2 | 4.0 | 7.0 | 1550 |
| 7V5 | 7.0 | 7.9 | 3 | 2.5 | 5.5 | 35 | 150 | 1 | 4.5 | 5.0 | 1500 |
| 8V2 | 7.7 | 8.7 | 5 | 3.1 | 6.1 | 25 | 150 | 0.7 | 5.0 | 5.0 | 1400 |
| 9V1 | 8.5 | 9.6 | 5 | 3.8 | 7.2 | 25 | 150 | 0.7 | 6.5 | 4.0 | 1340 |
| 10 | 9.4 | 10.6 | 8 | 4.7 | 8.5 | 25 | 90 | 0.2 | 7.0 | 4.0 | 1200 |
| 11 | 10.4 | 11.6 | 10 | 5.3 | 9.3 | 20 | 85 | 0.2 | 7.7 | 3.0 | 1100 |
| 12 | 11.4 | 12.7 | 10 | 6.3 | 10.8 | 20 | 85 | 0.2 | 8.4 | 3.0 | 1000 |
| 13 | 12.4 | 14.1 | 10 | 7.4 | 12.0 | 20 | 80 | 0.2 | 9.1 | 3.0 | 900 |
| 15 | 13.8 | 15.6 | 15 | 8.9 | 13.6 | 15 | 75 | 0.05 | 10.5 | 2.5 | 760 |
| 16 | 15.3 | 17.1 | 15 | 10.7 | 15.4 | 15 | 75 | 0.05 | 11.0 | 1.75 | 700 |
| 18 | 16.8 | 19.1 | 20 | 11.8 | 17.1 | 15 | 70 | 0.05 | 12.5 | 1.75 | 600 |
| 20 | 18.8 | 21.2 | 24 | 13.6 | 19.1 | 10 | 60 | 0.05 | 14.0 | 1.75 | 540 |
| 22 | 20.8 | 23.3 | 25 | 16.6 | 22.1 | 10 | 60 | 0.05 | 15.5 | 1.5 | 500 |
| 24 | 22.8 | 25.6 | 30 | 18.3 | 24.3 | 10 | 55 | 0.05 | 17 | 1.5 | 450 |
| 27 | 25.1 | 28.9 | 40 | 20.1 | 27.5 | 8 | 50 | 0.05 | 19 | 1.2 | 400 |
| 30 | 28.0 | 32.0 | 45 | 22.4 | 32.0 | 8 | 50 | 0.05 | 21 | 1.2 | 380 |
| 33 | 31.0 | 35.0 | 45 | 24.8 | 35.0 | 8 | 45 | 0.05 | 23 | 1.0 | 350 |
| 36 | 34.0 | 38.0 | 50 | 27.2 | 39.9 | 8 | 45 | 0.05 | 25 | 0.9 | 320 |
| 39 | 37.0 | 41.0 | 60 | 29.6 | 43.0 | 6 | 45 | 0.05 | 27 | 0.8 | 296 |
| 43 | 40.0 | 46.0 | 75 | 34.0 | 48.3 | 6 | 40 | 0.05 | 30 | 0.7 | 270 |
| 47 | 44.0 | 50.0 | 100 | 37.4 | 52.5 | 4 | 40 | 0.05 | 33 | 0.6 | 246 |
| 51 | 48.0 | 54.0 | 125 | 40.8 | 56.5 | 4 | 40 | 0.05 | 36 | 0.5 | 226 |
| 56 | 52.0 | 60.0 | 150 | 46.8 | 63.0 | 4 | 40 | 0.05 | 39 | 0.4 | 208 |
| 62 | 58.0 | 66.0 | 175 | 52.2 | 72.5 | 4 | 35 | 0.05 | 43 | 0.4 | 186 |
| 68 | 64.0 | 72.0 | 200 | 60.5 | 81.0 | 4 | 35 | 0.05 | 48 | 0.35 | 171 |
| 75 | 70.0 | 80.0 | 225 | 66.5 | 88.0 | 4 | 35 | 0.05 | 53 | 0.3 | 161 |



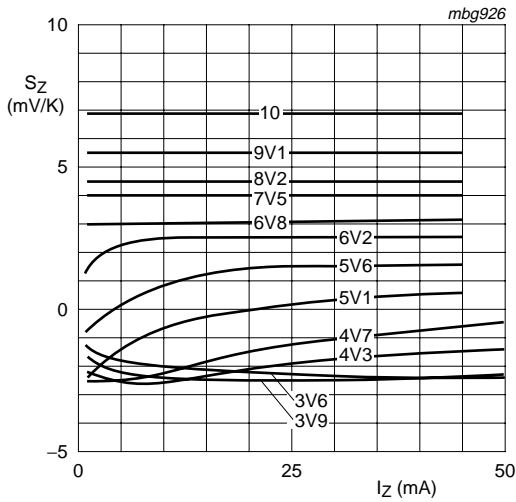
- (1) $t_p = 10 \mu s$; half sine wave; $T_{amb} = 25^\circ C$
- (2) $t_p = 10 ms$; half sine wave; $T_{amb} = 25^\circ C$

Fig 2. Non-repetitive peak reverse current as a function of the nominal working voltage



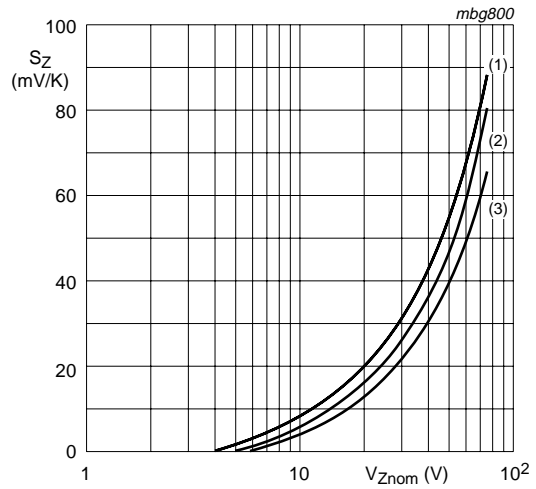
- (1) $T_j = 200^\circ C$
- (2) $T_j = 25^\circ C$

Fig 3. Forward current as a function of forward voltage; typical values



BZV85-C3V6 to BZV85-C10
 $T_j = 25^\circ C$ to $150^\circ C$
 For types above 7.5 V the temperature coefficient is independent of current; see [Table 8](#).

Fig 4. Temperature coefficient as a function of working current; typical values



- $I_z = I_{test}$
 $T_j = 25^\circ C$ to $150^\circ C$
- (1) Maximum values
 - (2) Typical values
 - (3) Minimum values

Fig 5. Temperature coefficient as a function of working current; typical values

8. Package outline

Hermetically sealed glass package; axial leaded; 2 leads

SOD66

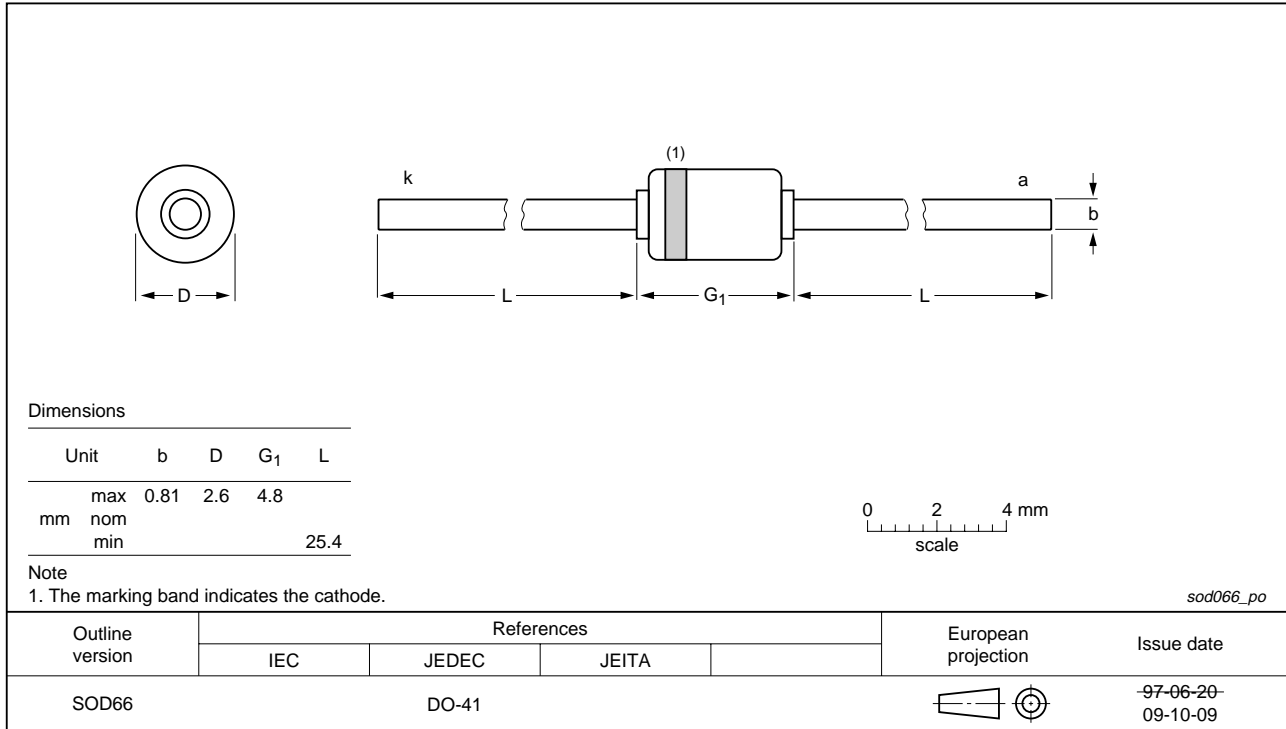


Fig 6. Package outline SOD66 (DO-41)

9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

| Type number | Package | Description | Packing quantity |
|-----------------------------|---------|----------------------------|------------------|
| | | | 10000 |
| BZV85 series ^[2] | SOD66 | 52 mm tape ammopack, axial | -133 |
| | | 52 mm reel pack, axial | -113 |

[1] For further information and the availability of packing methods, see [Section 11](#).

[2] The series consists of 33 types with nominal working voltages from 3.3 V to 75 V.

10. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--------------|---|---------------|------------|
| BZV85_SER_3 | 20091110 | Product data sheet | - | BZV85_2 |
| Modifications: | | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Table 6: $R_{th(j-tp)}$ redefined to $R_{th(j-t)}$ thermal resistance from junction to tie-point Figure 1: $R_{th(j-tp)}$ redefined to $R_{th(j-t)}$ thermal resistance from junction to tie-point Table 8 "Characteristics per type": I_{Ztest} redefined to I_{test} test current Figure 6 "Package outline SOD66 (DO-41)": updated | | |
| BZV85_2 | 19990511 | Product specification | - | BZV85_1 |
| BZV85_1 | 19960426 | Product specification | - | - |

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| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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